

Dual Common-Cathode Ultra Low VF Schottky Rectifier

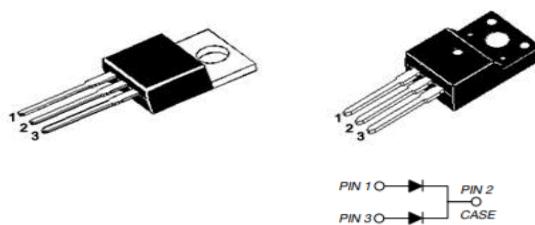
FEATURES AND BENEFITS

- Low power loss, high efficiency operation
- Low forward voltage drop
- Fast switching capability
- High forward surge capability
- Excellent High Temperature Stability

MECHANICAL DATA

- Epoxy : UL94 V-0 rated flame retardant
- Case : TO-220AB / ITO-220AB Package
- Terminals : Matte Tin annealed over copper
- Weight : Approximated 2.03 grams

Primary Characteristic	
I _O	2X15A
V _{RRM}	100V
I _{FSM}	180A
V _F Typical=2.5A , T _J =125°C	0.36V
T _{Jmax}	175°C



Maximum Ratings (Ta=25°C unless otherwise specified)

Characteristics	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	100	V
Working Peak Reverse Voltage	V _{RWM}	100	V
DC Blocking Voltage	V _{DC}	100	V
RMS Reverse Voltage	V _{RMS}	70	V
Average Forward Rectified Current (per diode)	I _O	15	Amps
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	180	Amps

Electrical Characteristics (Ta=25°C unless otherwise specified)

Characteristics	Symbol	Typ.	Max.	Unit
Forward Voltage Drop ¹⁾	I _F =2.5A	V _F	0.44	V
	I _F =15A	V _F	0.69	V
	I _F =2.5A	V _F	0.36	V
	I _F =15A	V _F	0.61	V
Reverse Current ²⁾	V _R =100V	I _R	15	μA
	V _R =100V	I _R	5	mA

THERMAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Characteristics	Symbol	Value	Unit
Typical Thermal Resistance, junction to case	R _{θJC}	2.8	°C/W
Typical Thermal Resistance, junction to case	R _{θJC}	4.0	°C/W
Operating Temperature Range (in DC Mode)	T _J	-65 to +175	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

Notes (1): Pulse test: 300μs pulse width, 1% duty cycle.

Notes (2): Pulse width ≤40ms

Notes (3): FR-4 PCB, 2oz copper. Minimum recommended pad layout

RATINGS AND CHARACTERISTICS CURVES

Fig 1. Typical Forward Characteristics

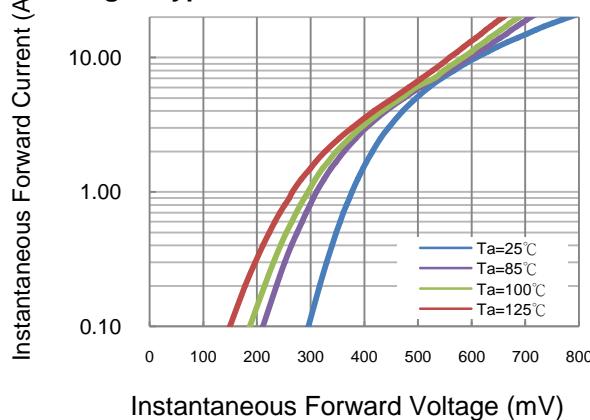


Fig 2. Typical Reverse Characteristics

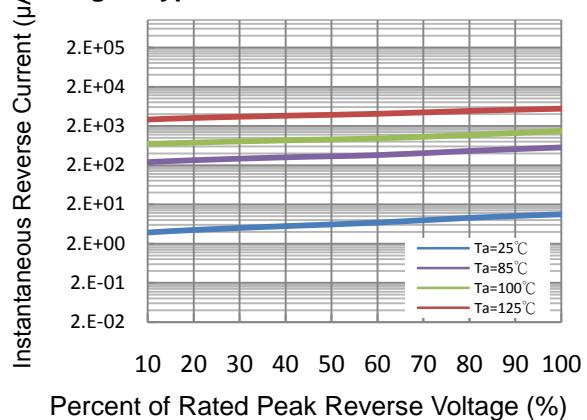


Fig 3. Typical Forward Current Derating Curve

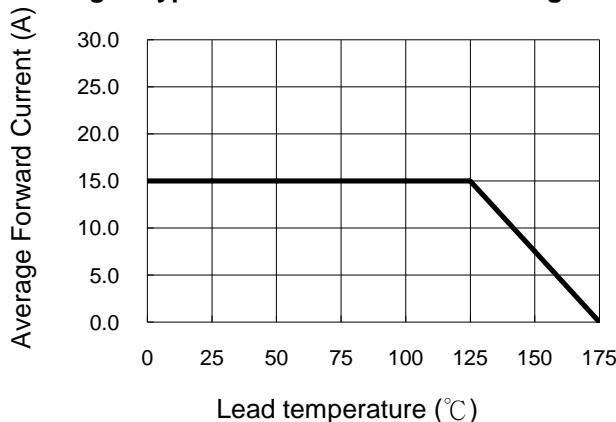
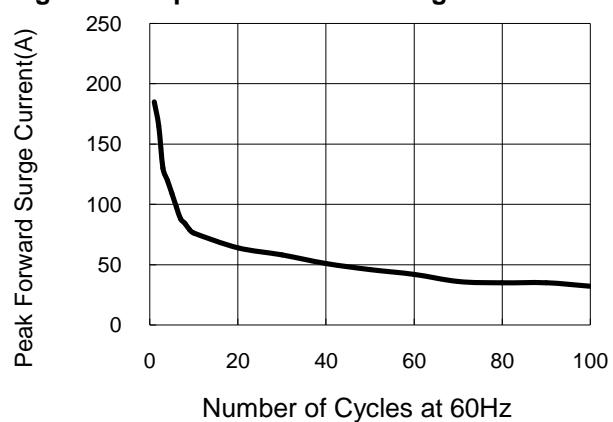


Fig 4. Non-repetitive Forward Surge Current



Package Outline Dimensions (in millimeters)

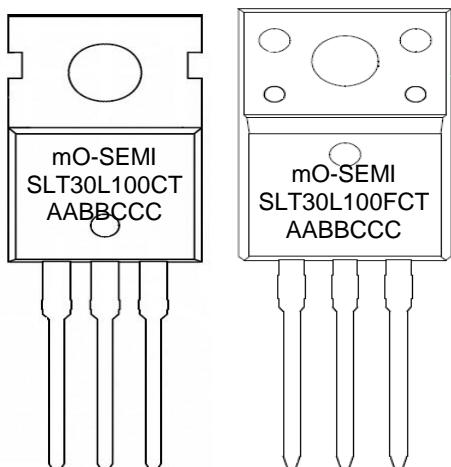
ITO-220				
SYMBOL	Dimensions			
	Millimeters		Inches	
	Min	Max	Min	Max
A	4.60	4.80	0.18	0.19
b	0.70	0.91	0.03	0.04
b1	1.20	1.47	0.05	0.06
b2	1.10	1.30	0.04	0.05
C	0.45	0.63	0.02	0.02
D	15.80	15.97	0.62	0.63
e	2.54			
E	10.00	10.10	0.39	0.40
F	2.44	2.54	0.10	0.10
G	6.50	6.70	0.26	0.26
L	12.90	13.10	0.51	0.52
L1	3.13	3.23	0.12	0.13
Q	2.65	2.75	0.10	0.11
Q1	3.20	3.30	0.13	0.13
ψP	3.08	3.18	0.12	0.13

The technical drawing for the ITO-220 package includes two views: a top view and a bottom view. The top view shows the lead configuration with dimensions E, F, G, L, L1, Q, Q1, ψP, and various lead spacings (3Xb1, 3Xb2, 3Xb). The bottom view shows the lead configuration with dimensions A, A1, A2, A3, C, D, H1, H2, and features like Mold Flash Bleeding and Exposed Cu. Callouts point to specific features such as the exposed copper pads on the leads.

TO-220				
SYMBOL	Dimensions			
	Millimeters		Inches	
	Min	Max	Min	Max
A	3.56	4.82	0.14	0.19
A1	0.51	1.39	0.02	0.05
A2	2.04	2.92	0.08	0.11
b	0.39	1.01	0.02	0.04
b1	1.15	1.82	0.05	0.07
b2	1.15	1.77	0.05	0.07
c	0.04	0.50	0.00	0.02
D	14.22	16.51	0.56	0.65
D1	8.39	9.01	0.33	0.35
D2	11.45	12.87	0.45	0.51
E	9.66	10.66	0.38	0.42
E1	6.86	8.89	0.27	0.35
e	2.54BSC		2.54BSC	
e1	5.08BSC		5.08BSC	
H1	5.85	6.85	0.23	0.27
L	12.70	14.73	0.50	0.58
L1	-	6.35	-	0.25
L2	15.80	16.20	0.62	0.64
ψP	3.54	4.08	0.14	0.16
Q	2.54	3.42	0.10	0.13

The technical drawing for the TO-220 package includes two views: a top view and a bottom view. The top view shows the lead configuration with dimensions E, F, G, L, L1, Q, Q1, ψP, and various lead spacings (3Xb1, 3Xb2, 3Xb). The bottom view shows the lead configuration with dimensions A, A1, A2, A3, C, D, H1, H2, and features like Exposed Cu. Callouts point to specific features such as the exposed copper pads on the leads.

Marking Information



mO-SEMI
SLT30L100
AABBCCC
*FCT=ITO-220
*CT=TO-220

=Series Name
=Part Number Marking Code
=Product Tracking Code
=Dual ITO-220
=Dual TO-220